

<Transistor>

2SC5383

For Low Frequency Amplify Application
Silicon NPN Epitaxial Type Ultra Super Mini

DESCRIPTION

2SC5383 is a super mini silicon NPN epitaxial type transistor designed for low frequency voltage amplify application.

FEATURE

- Low collector to emitter saturation voltage.
 $V_{CE(sat)}=0.3V$ max (@ $I_C=100mA, I_B=10mA$)
- Excellent linearity DC forward current gain
- Super mini package for easy mounting

APPLICATION

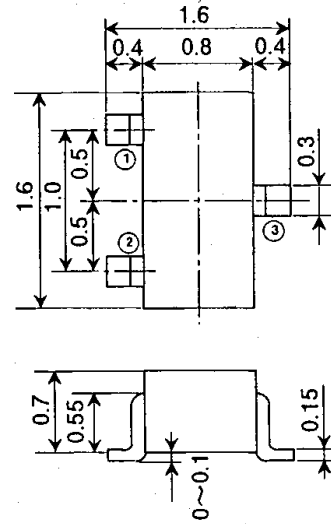
For hybrid IC, small type machine low frequency voltage amplify application.

MAXIMUM RATINGS ($T_a=25^\circ C$)

SYMBOL	PARAMETER	RATINGS	UNIT
V_{CBO}	Collector to Base voltage	50	V
V_{EBO}	Emitter to Base voltage	6	V
V_{CEO}	Collector to Emitter voltage	50	V
I_C	Collector current	200	mA
P_C	Collector dissipation ($T_a=25^\circ C$)	125	mW
T_j	Junction temperature	+125	$^\circ C$
T_{stg}	Storage temperature	-55 to +125	$^\circ C$

OUTLINE DRAWING

UNIT:mm



Terminal Connector

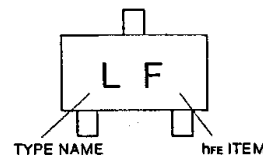
- ① : Base
- ② : Emitter
- ③ : Collector

EIAJ : —
JEDEC : —

Note)

The dimension without tolerance represent central value.

MARKING



ELECTRICAL CHARACTERISTICS ($T_a=25^\circ C$)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
$V_{(BR)CEO}$	C to E break down voltage	$I_C=100\mu A, R_{BE}=\infty$	50			V
I_{CBO}	Collector cut off current	$V_{CB}=50V, I_E=0$			0.1	μA
I_{EBO}	Emitter cut off current	$V_{EB}=6V, I_C=0$			0.1	μA
h_{FE}^*	DC forward current gain	$V_{CE}=6V, I_C=1mA$	150		800	—
h_{FE}	DC forward current gain	$V_{CE}=6V, I_C=0.1mA$	90			—
$V_{CE(sat)}$	C to E saturation voltage	$I_C=100mA, I_B=10mA$			0.3	V
f_T	Gain band width product	$V_{CE}=6V, I_E=-10mA$		200		MHz
C_{ob}	Collector output capacitance	$V_{CB}=6V, I_E=0, f=1MHz$		2.5		pF
NF	Noise figure	$V_{CE}=6V, I_E=-0.1mA, f=1kHz, R_G=2k\Omega$			15	dB

ITEM	E	F	G
hFE	150~300	250~500	400~800

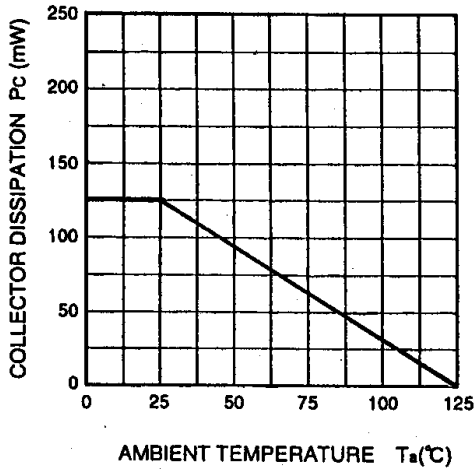
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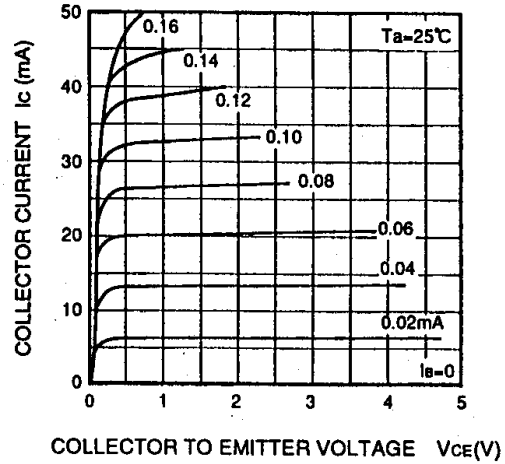
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TYPICAL CHARACTERISTICS

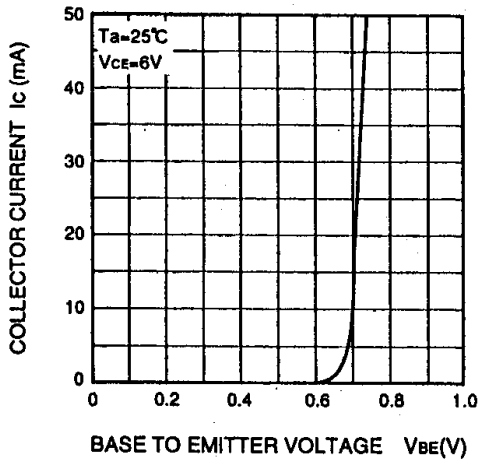
COLLECTOR DISSIPATION VS. AMBIENT TEMPERATURE



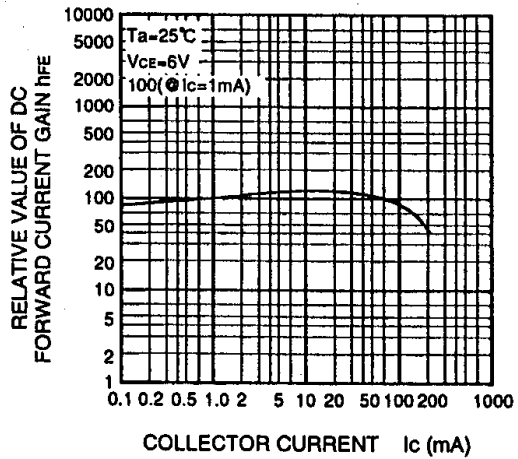
COMMON EMITTER OUTPUT



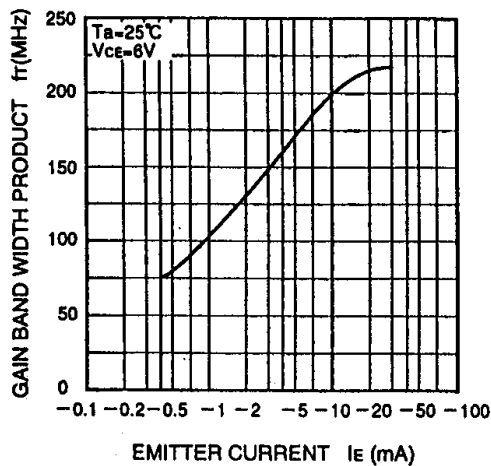
COMMON EMITTER TRANSFER



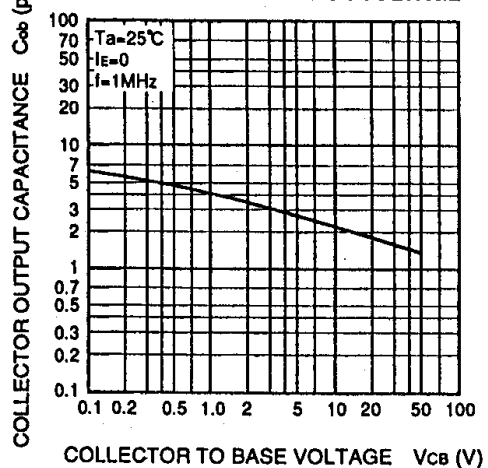
DC FORWARD CURRENT GAIN VS. COLLECTOR CURRENT



GAIN BAND WIDTH PRODUCT VS. EMITTER CURRENT



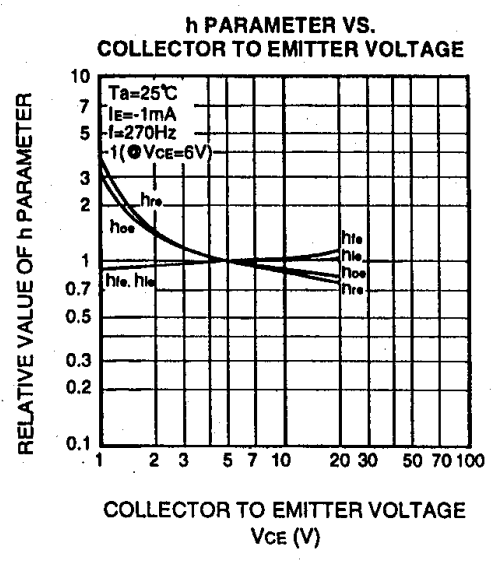
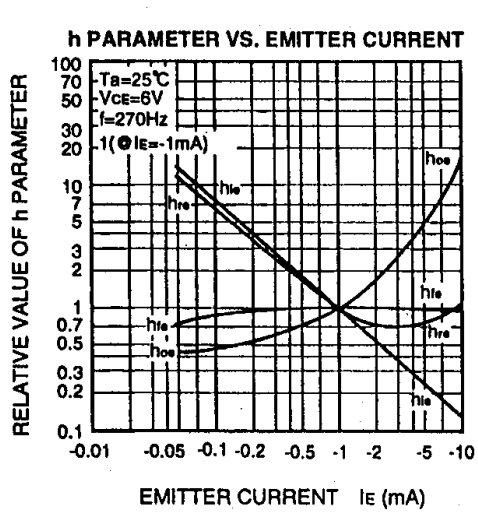
COLLECTOR OUTPUT CAPACITANCE VS. COLLECTOR TO BASE VOLTAGE



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COMMON EMITTER h PARAMETER (TYPICAL VALUE)

Symbol	Parameter	Test conditions	Limits	Unit
h_{ie}	Closed loop small signal input impedance	$T_a=25^\circ\text{C}$ $V_{CE}=6\text{V}$ $I_E=1\text{mA}$ $f=270\text{Hz}$	8.5	k Ω
h_{re}	Open loop small signal reverse voltage amplification factor		0.1	$\times 10^{-3}$
h_{fe}	Closed loop small signal forward current amplification factor		300	—
h_{oe}	Open loop small signal output admittance		5.5	μS

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